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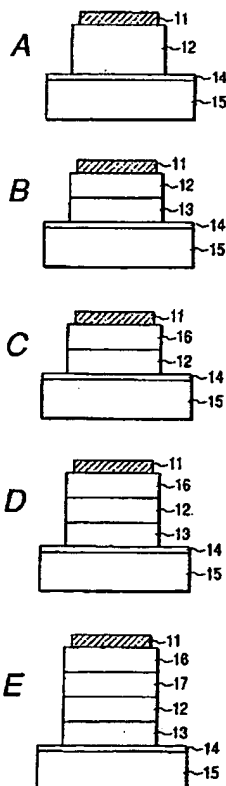
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(54) Title: LUMINESCENT DEVICE



(57) Abstract: The present invention provides a luminescent device using a luminescent material which has high luminescence efficiency and high stability, and is available at a low cost. The luminescent device is characterized in that as a luminescent material is used a binuclear copper coordination compound having a partial structure represented by the general formula (1): Cu-A-Cu, wherein Cu is a copper ion and A is a bidentate ligand.

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